

## Multilayer board, 26L HDI PCB,FR-4

### Product Description:

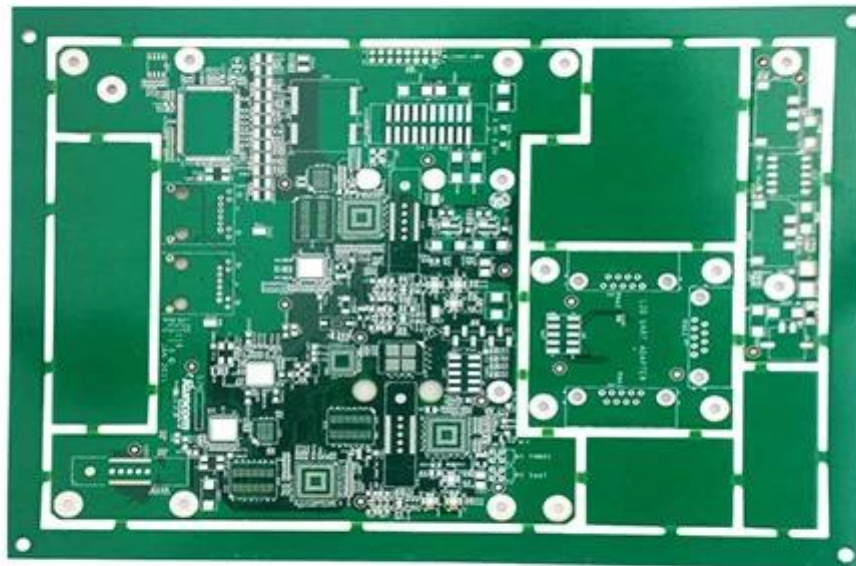
Place of Origin	Guang dong, China (Mainland)	Brand Name	O-Leading
Base Material	NPG-150N	Copper Thickness	1oz
Min. Hole Size	0.2mm	Min. Line Width	2.35mil
Surface Finishing	immersion gold	Min. Line Spacing	3mil
applicable to	Industry control	character	Industrial Control
certificates	ISO9001,UL,RoHS,SGS	Q/CTN	10PCS-100PCS
weight	0.01kg -5kg	MOQ	10pcs
Model Number	power bank pcb assembly pcba manufacturer	Board Thickness	0.1-5mm
color	green	price	\$0.1-\$10
design type	customer requirement	size	0.01m3-10m3

### Packaging & Delivery

Packaging Details	16 years professional OEM client board manufacturer
Delivery Detail	7-12days

### Product Description

item	2017		2018~2020		2021~2023	
	Volume	Sample	Volume	Sample	Volume	Sample
Layer count	32	42	38	44	42	48
Min Line/space (µm)	50/50	40/45	40/45	40/40	35/40	35/35
Min drill hole diameter (mm)	0.15	0.10	0.15	0.10	0.15	0.10
Aspect ratio of PTH	14:1	16:1	16:1	18:1	18:1	20:1
N+C+N	4+C+4	5+C+5	5+C+5	6+C+6	5+C+5	6+C+6
Any layer interconnection	5+2+5	6+2+6	5+2+5	6+2+6	5+2+5	6+2+6
Plate filling via	YES	--	YES	--	YES	--
Min. core thickness (exclude copper) (µm)	50	40	40	thirty	40	thirty
Min. Laser Drill diameter (µm)	75	65	65	50	50	40
Via on buried hole/stacked via	YES	--	YES	--	YES	--
Material	FR4, Megtron, Nelco, Rogers, Heavy Copper, etc.					
Embedded capacitor PCB	YES	--	YES	--	YES	--
Surface Process	Lead-free HASL, ENIG, OSP, silver with immersion, tin of immersion, Flash of gold, Golden finger coating, Selective solid gold coating, Flaking solder mask, carbon ink					



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[HDI pcb Printed circuit board](#)